

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Applicant:

Application No.:

Filed:

For:

Abbott, et al Art Unit: 2826

09/525,105

Examiner: Williams, A.

03/14/00

Docket: TI-28098

GOLD SPOT PLATED LEADFRAMES FOR SEMICONDUCTOR

DEVICES AND METHOD OF FARBICATION **DEVICES AND METHOD OF FABRICATION**

AMENDMENT 37 CFR 1.116

June 13, 2002

Assistant Commissioner for Patents Washington, D.C. 20231

I hereby certify that the above correspondence is being deposited with the U.S. Postal Service as First Class Mail bearing sufficient postage in an envelope addressed to: Assistant Commissioner for Patents,

Washington, D.C. 20231 on June 13, 2002

Sir:

Responsive to the Office Action of April 17, 2002, favorable reconsideration and allowance of the application are respectfully requested.

The rejection of claim 1 as unpatentable over Ito et al is respectfully traversed, since the reference fails to disclose or suggest applicants' invention. Contrary to the Examiner's comment, there is NO disclosure in Ito relating to any gold layer on elements 82b and 83b. The Examiner appears to be mistaken. The rejection is therefore improper and should be withdrawn.



If the Examiner insists that such a disclosure appears in the reference, please indicate column and line numbers where it can be found.

The rejection of claims 2 - 13 and 15 as unpatentable over Abbott in view of Akino et al and Ito et al is respectfully traversed, since the references fail to disclose or suggest applicant's invention. Since there is no disclosure or suggestion of any gold layer on Ito parts 82b and 83b, the rejection is clearly improper and should be withdrawn.

Applicants now believe the application is in condition for allowance.

Respectfully submitted,

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June 13, 2002

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VIA FIRST CLASS MAIL

Assistant Commissioner for Patents Washington, D.C. 20231-9998

Re:

Amendment 37 CFR 1.116

Title:

FOR GOLD SPOT PLATED **LEADFRAMES**

SEMICONDUCTOR DEVICES AND **METHOD OF**

FABRICATION

Appl. No.:

09/525,105

Dear Sir:

Enclosed please find the following items relating to the above-identified patent (1) Amendment 37 CFR 1.116; and (3) Postcards.

Please return the date-stamped postcard to our office ve any questions or comments comments commented. Otherwise the comments commented to the comment of the comm *Please return the date-stamped postcard to our offices at the above address. In the meantime if you have any questions or comments concerning this matter, please call the undersigned at your earliest convenience. Otherwise, please accept the enclosed.

Reg. No. 20,250

GCH/msg Enclosures

cc: James Brady, Texas Instruments Incorporated